

# AP9475M-VB Datasheet N-Channel 60-V (D-S) MOSFET

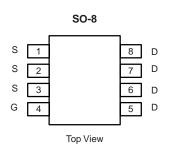
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
60	0.025 at V <sub>GS</sub> = 10 V	7.6	10.5 nC			
60	0.035 at V <sub>GS</sub> = 4.5 V	6.5	10.5110			

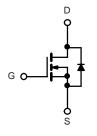
## **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- Optimized for "Low Side" Synchronous Rectifier Operation
- 100 % R<sub>g</sub> and UIS Tested



ROHS
COMPLIANT
HALOGEN
FREE





N-Channel MOSFET

## **APPLICATIONS**

CCFL Inverter

<b>ABSOLUTE MAXIMUM RATINGS</b> T	$_{A}$ = 25 °C, unless other	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	60	V	
Gate-Source Voltage	$V_{GS}$	± 20	v	
	T <sub>C</sub> = 25 °C		7.6 <sup>a</sup>	
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1 , [	6.8	
Continuous Diain Current (1) = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	6.1 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		4.8 <sup>b, c</sup>	
Pulsed Drain Current	<u>.</u>	I <sub>DM</sub>	25	A
Continuous Course Dunin Binds Courset	T <sub>C</sub> = 25 °C		4.2	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	ls –	2.1 <sup>b, c</sup>	
Avalanche Current	1 04	I <sub>AS</sub>	15	
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	11.2	mJ
	T <sub>C</sub> = 25 °C		5	
Manine Davis Dissination	T <sub>C</sub> = 70 °C		3.2	10/
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	W
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	20	25	- C/VV	

### Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 250		55		\//00
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 6.3		mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2		2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	I <sub>DSS</sub>	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	1		1	
Zero Gate Voltage Drain Current		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	10 µA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α
D : 0	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4.6 A		0.025		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 4.2 \text{ A}$	0.035			Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 4.6 \text{ A}$		20		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			1100		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		90		
Reverse Transfer Capacitance	C <sub>rss</sub>			55		
Total Cata Charga	0	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 4.6 \text{ A}$		21	32	nC
Total Gate Charge	Q <sub>g</sub>			10.5	16	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 4.6 \text{ A}$		3.5		
Gate-Drain Charge	$Q_{gd}$			4.2		
Gate Resistance	$R_{g}$	f = 1 MHz		3.3	5	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			20	30	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, $R_L$ = 5.4 $\Omega$		150	225	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D\cong 5.6$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		20	30	
Fall Time	t <sub>f</sub>			60	90	no
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, $R_L$ = 5.4 $\Omega$		15	25	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D\cong 5.6$ A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		25	40	
Fall Time	t <sub>f</sub>			10	15	
<b>Drain-Source Body Diode Characterist</b>	ics					
Continous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			4.2	А
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				25	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			25	50	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			25	50	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 5.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		19		nc
Reverse Recovery Rise Time	t <sub>b</sub>			6		ns

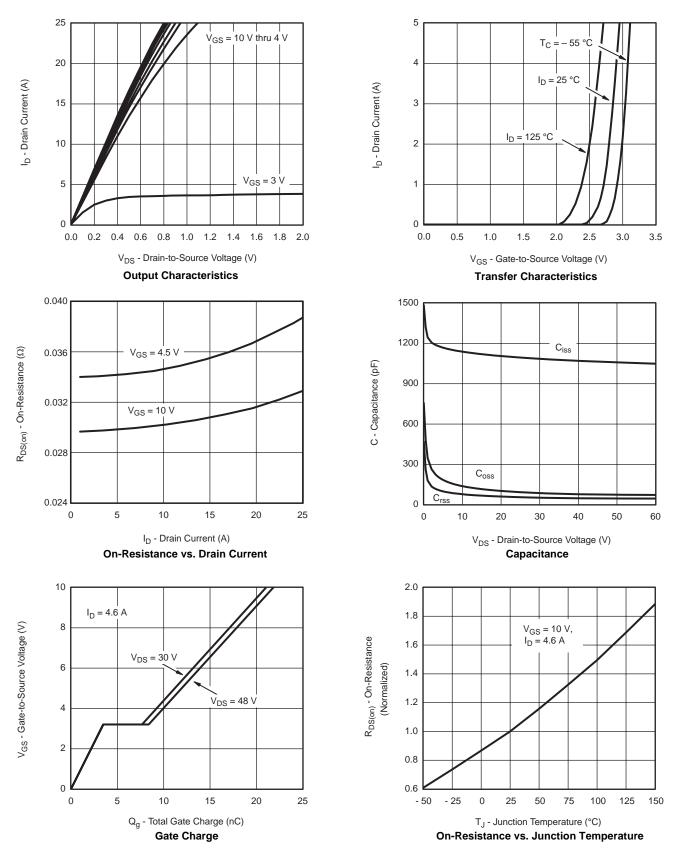
## Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

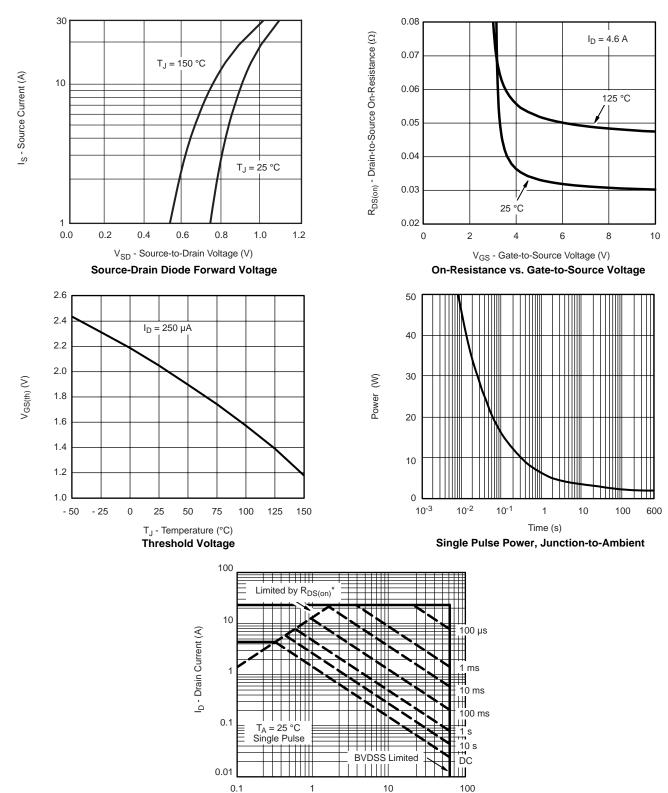
a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.





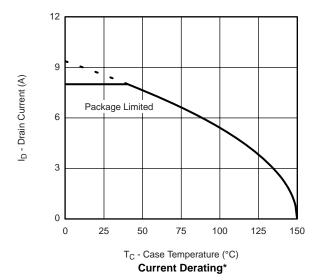


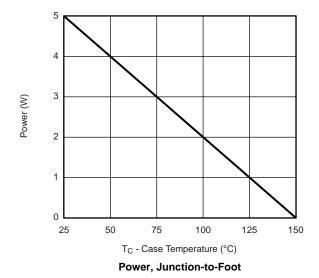


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$$\begin{split} & \text{$V_{DS}$ - Drain-to-Source Voltage (V)$} \\ ^* \text{$V_{GS}$ > minimum $V_{GS}$ at which $R_{DS(on)}$ is specified} \\ & \textbf{Safe Operating Area} \end{split}$$

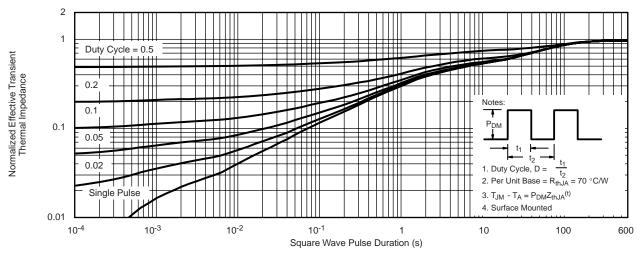




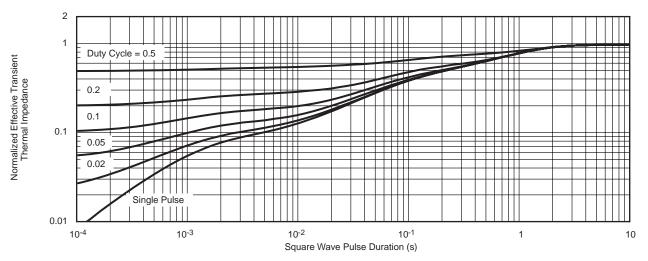


<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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**SOIC (NARROW): 8-LEAD**JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
FCN: C-06527-Rev I 11-Sen-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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